ACM120B028TD

N-Channel Silicon Carbide Power MOSFET

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)MAX}$	I_D@25℃
1200V	38mΩ@18V	83A

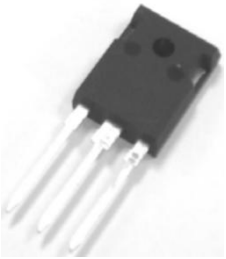
Feature

- Wide bandgap SiC MOSFET technology
- Low On-Resistance with High Blocking Voltage
- Low Capacitances with High-Speed switching
- Low reverse recovery(Qrr)

Application

- Switch Mode Power Supplies
- Renewable Energy
- Motor Drives
- High Voltage DC/DC Converters

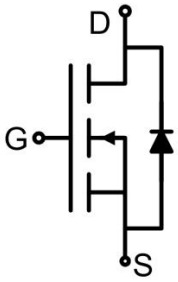
Package



TO-247-3L

Marking

Circuit diagram



Absolute maximum ratings (T_C=25℃ unless otherwise noted)

Parameter	Symbol	Test Condition	Value	Unit
Drain-Source Voltage	V_{DS}	V_{GS} =0V, I_D =100μA	1200	V
Gate-Source Voltage	V_{GSmax}	t_p≤500ns, duty cycle ≤1%	-8/+20	V
Gate-Source Voltage	V_{GSOP}	Static	-4/+18	V
Continuous Drain Current	I_D	V_{GS} =18V	83	A
	I_D	V_{GS} =18V, T_C=100℃	59	A
Pulsed Drain Current	$I_{D,pulse}$	Pulse with t_p limited by T_{jmax}	165	A
Power Dissipation	P_D	T_J=175℃	341	W
Thermal Resistance（Typ）	$R_{\theta JC}$	Junction-to-Case	0.44	℃/W
Junction Temperature	T_J		-55~ +175	℃
Storage Temperature	T_{STG}		-55~ +175	℃

Electrical characteristics (T_J=25℃, unless otherwise noted)

Parameter	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS} =0V, I_D =100μA	1200			V
Zero gate voltage drain current	I_{DSS}	V_{DS} =1200V,V_{GS} =0V		1	50	μA
Gate-Source leakage current	I_{GSS}	V_{GS} =18V, V_{DS} =0V			250	nA
Gate threshold voltage	$V_{GS(th)}$	V_{DS} =V_{GS}, I_D =14mA		2.6		V
		V_{DS} =V_{GS}, I_D =14mA,T_J = 175℃		1.8		
Drain-source on-resistance	$R_{DS(on)}$	V_{GS} =15V, I_D =40A		32		mΩ
		V_{GS} =18V, I_D =40A		28	38	
		V_{GS} =15V, I_D =40A,T_J = 175℃		55		
		V_{GS} =18V, I_D =40A,T_J = 175℃		53		
Transconductance	g_{fs}	V_{GS} =15V, I_D =40A		26		S
		V_{GS} =15V, I_D =40A,T_J = 175℃		25		
Dynamic characteristics						
Input Capacitance	C_{iss}	V_{DS} =1000V,V_{GS} =0V,f =100kHz V_{AC} = 25mV		3708		pF
Output Capacitance	C_{oss}			107		
Reverse Transfer Capacitance	C_{rss}			6.9		
Total Gate Charge	Q_g	V_{DS} =800V,I_D =40A V_{GS} =-4V/18V		66		nC
Gate-Source Charge	Q_{gs}			32		
Gate-Drain Charge	Q_{gd}			25		
Internal Gate Resistance	$R_{G(int)}$	f=1 MHz, V_{AC} =25mV		0.8		Ω
Turn-on delay time	$t_{d(on)}$	V_{DS}=800V,V_{GS}=-4/+18V, I_D =40A,$R_{G(ext)}$=5Ω,L=200μH		4		nS
Turn-on rise time	t_r			35		
Turn-off delay time	$t_{d(off)}$			26		
Turn-off fall time	t_f			8		
Turn-On Energy	E_{on}			724		μJ
Turn-Off Energy	E_{off}			138		
Total switching energy	E_{tot}			862		
Source-Drain Diode characteristics						
Diode Forward Current	I_S	V_{GS} =-4V,T_C=25℃		75		A
Diode Forward voltage	V_{SD}	V_{GS} =-4V, I_{SD} =20A		3.9		V
		V_{GS} =-4V, I_{SD} =20A,T_J=175℃		3.5		
Reverse Recovery Time	t_{rr}	V_{GS} =-4V,I_{SD} =40A,V_R =800V dif/dt =3400 A/μs		27		nS
Reverse Recovery Charge	Q_{rr}			211		nC
Peak Reverse Recovery Current	I_{rrm}			14		A

Typical Characteristics

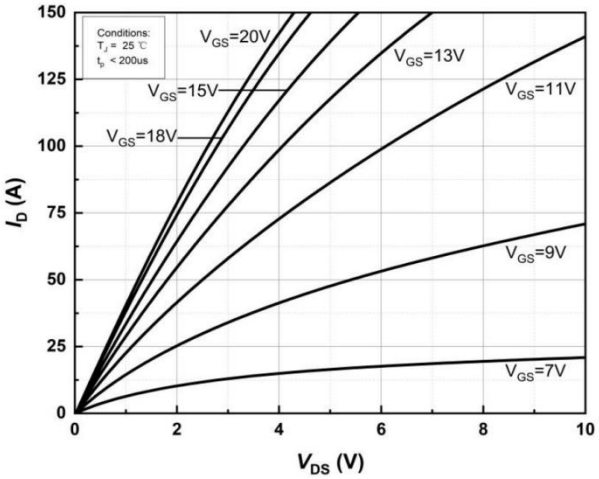


Figure 1. Output characteristics at Tj=25°C

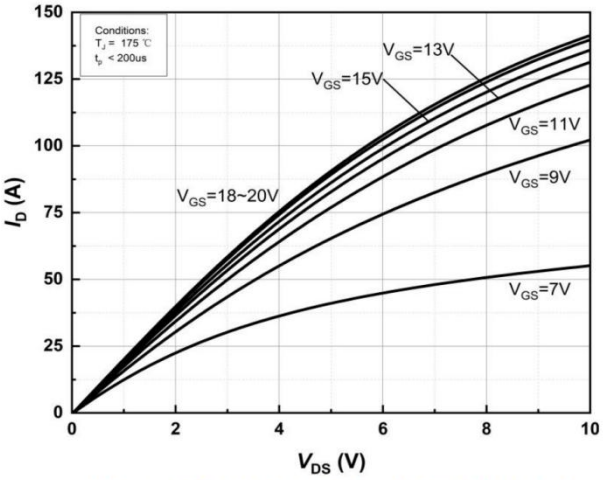


Figure 2. Output characteristics at Tj=175°C

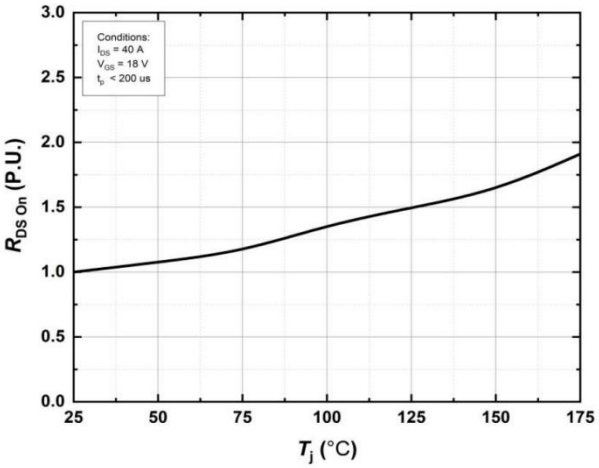


Figure 3. Normalized On-Resistance vs. Temperature

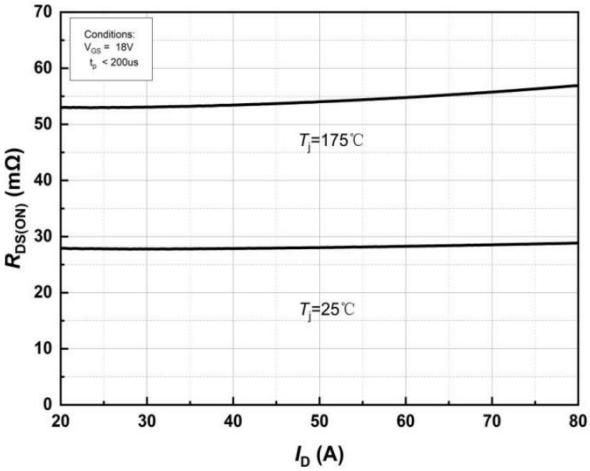


Figure 4. On-Resistance vs. Drain current for Various Temperature

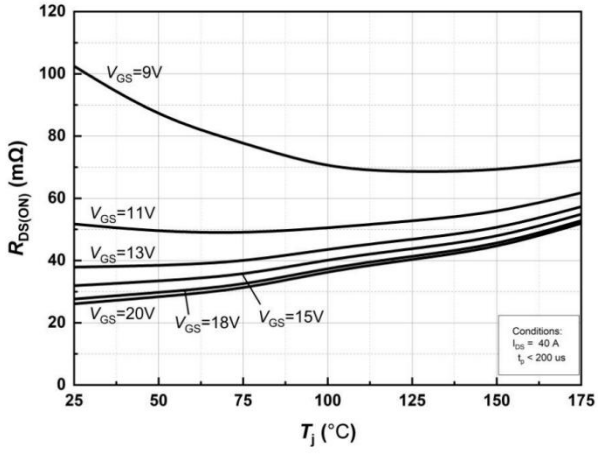


Figure 5. On-Resistance vs. Temperature for Various Gate Voltage

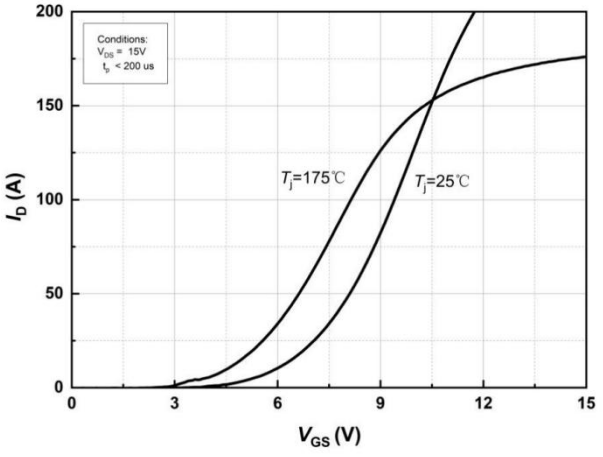


Figure 6. Transfer Characteristics for Various Junction Temperatures

Typical Characteristics

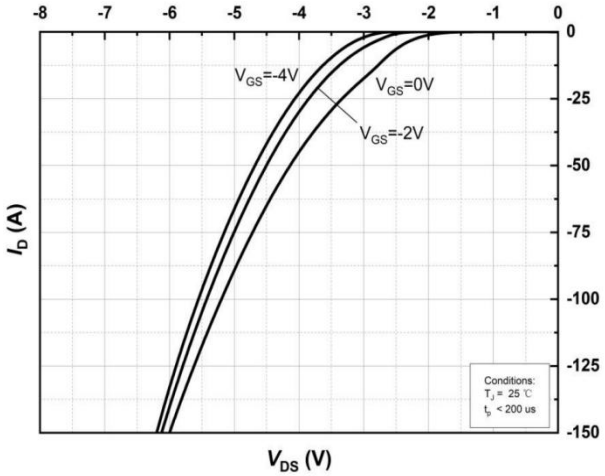


Figure 7. Body Diode Characteristics at Tj=25°C

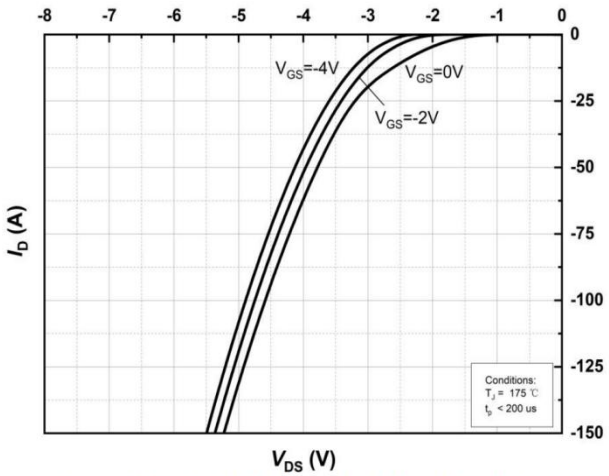


Figure 8. Body Diode Characteristics at Tj=175°C

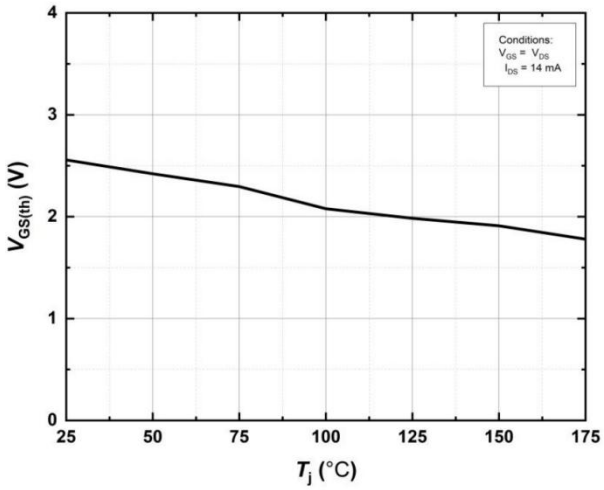


Figure 9. Threshold Voltage vs. Temperature

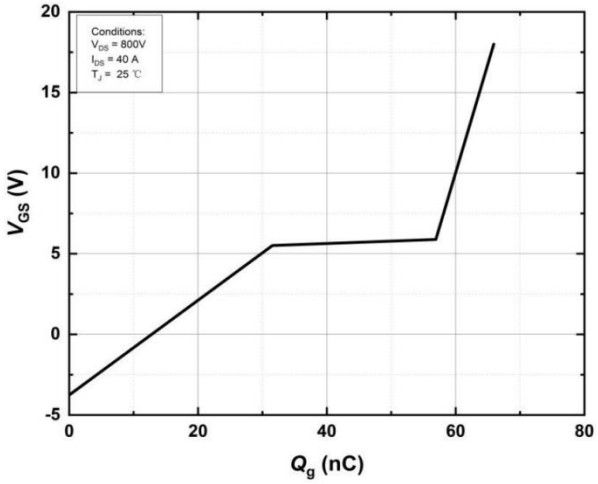


Figure 10 Gate Charge Characteristics

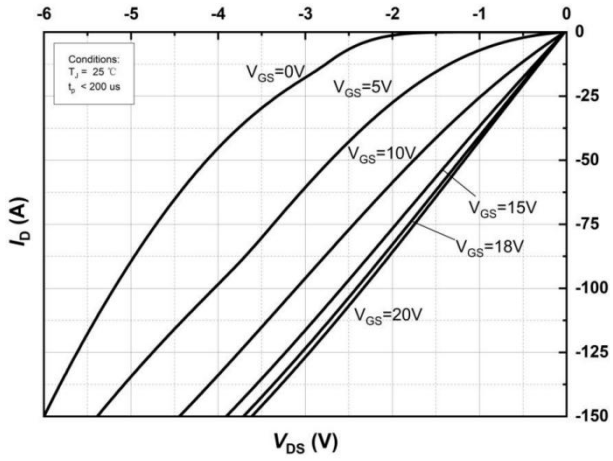


Figure 11. 3rd Quadrant Characteristic at Tj=25°C

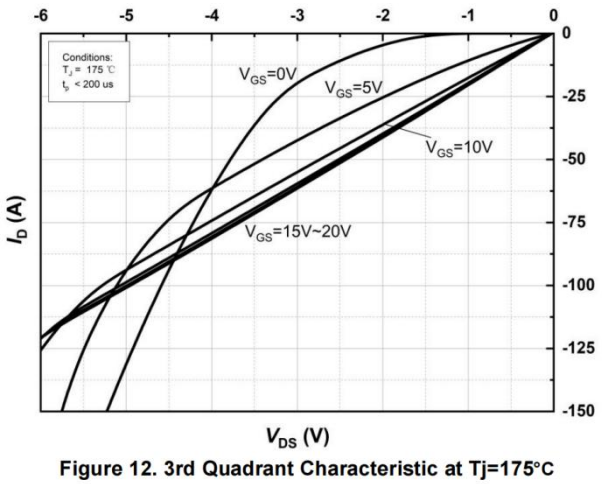


Figure 12. 3rd Quadrant Characteristic at Tj=175°C

Typical Characteristics

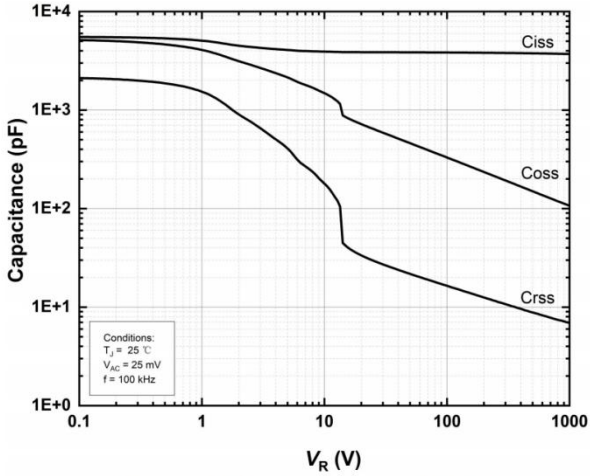


Figure 13. Capacitances vs. Drain-Source Voltage (0 – 1000V)

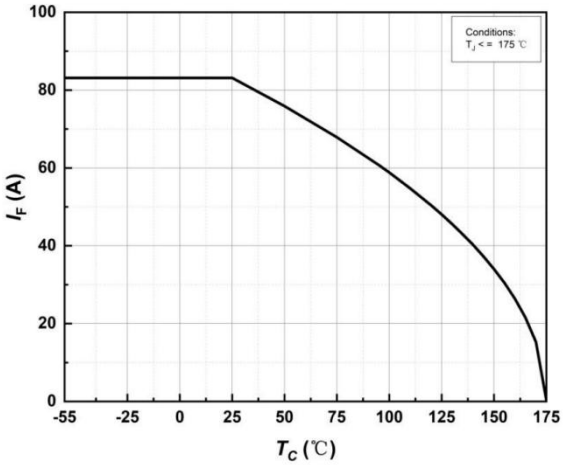


Figure 14. Continuous Drain Current Derating vs Case Temperature

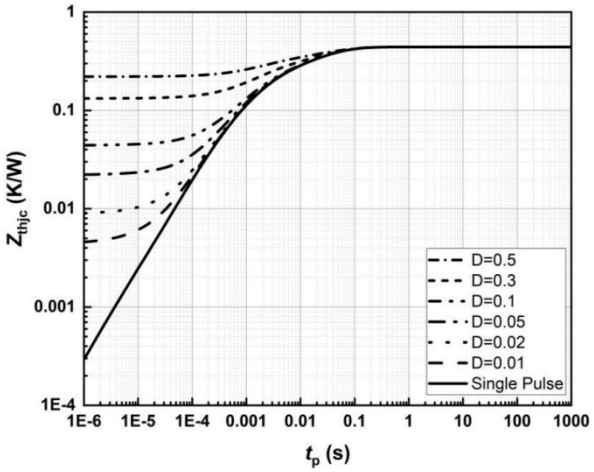


Figure 15.Transient Thermal Impedance (Junction – Case)

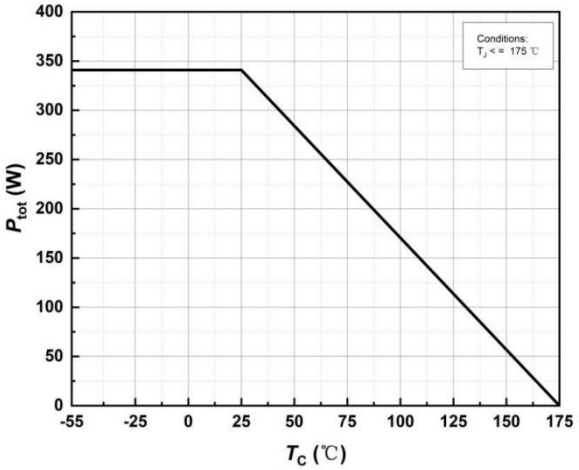


Figure 16. Maximum Power Dissipation Derating vs. Case Temperature

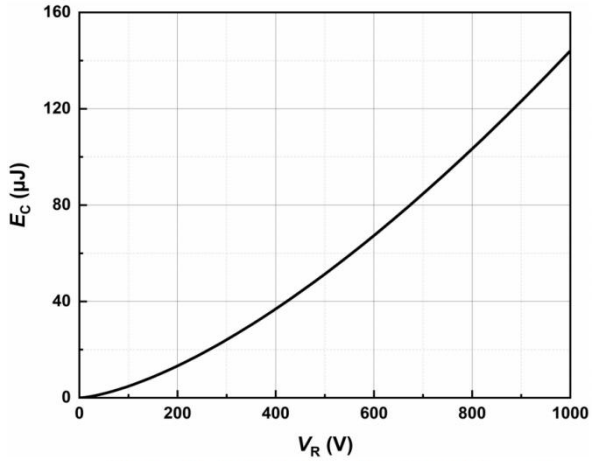


Figure 17. Output Capacitor Stored Energy

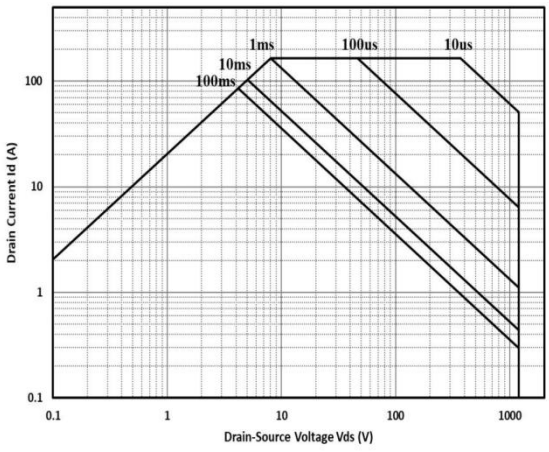


Figure 18. Safe Operating Area

Typical Characteristics

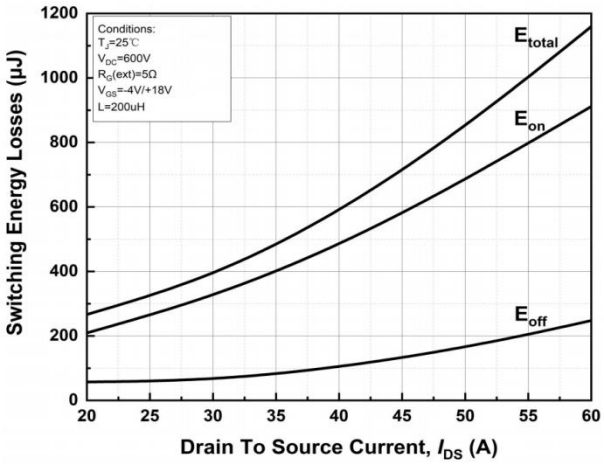


Figure 19. Clamped Inductive Switching Energy vs. Drain Current(V_{DD} = 600V)

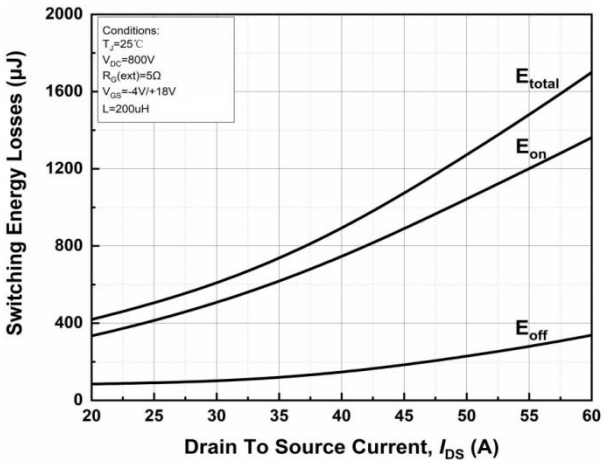


Figure 20. Clamped Inductive Switching Energy vs. Drain Current(V_{DD} = 800V)

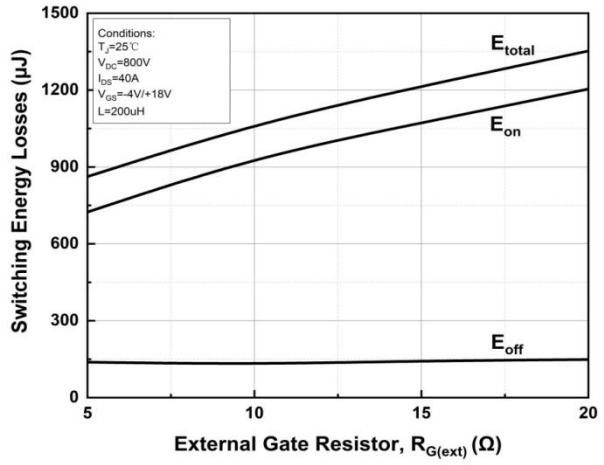


Figure 21. Clamped Inductive Switching Energy vs. $R_{G(ext)}$

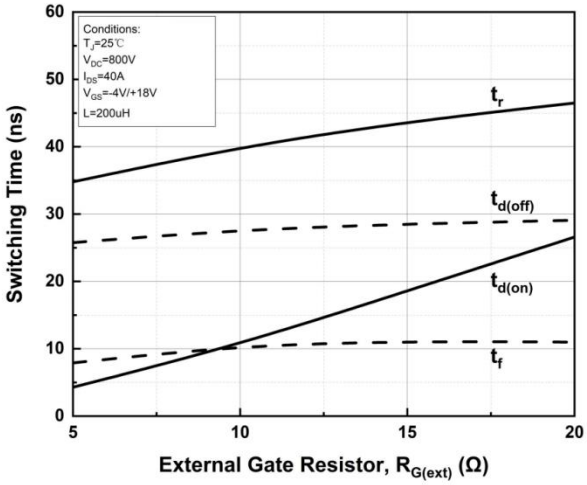
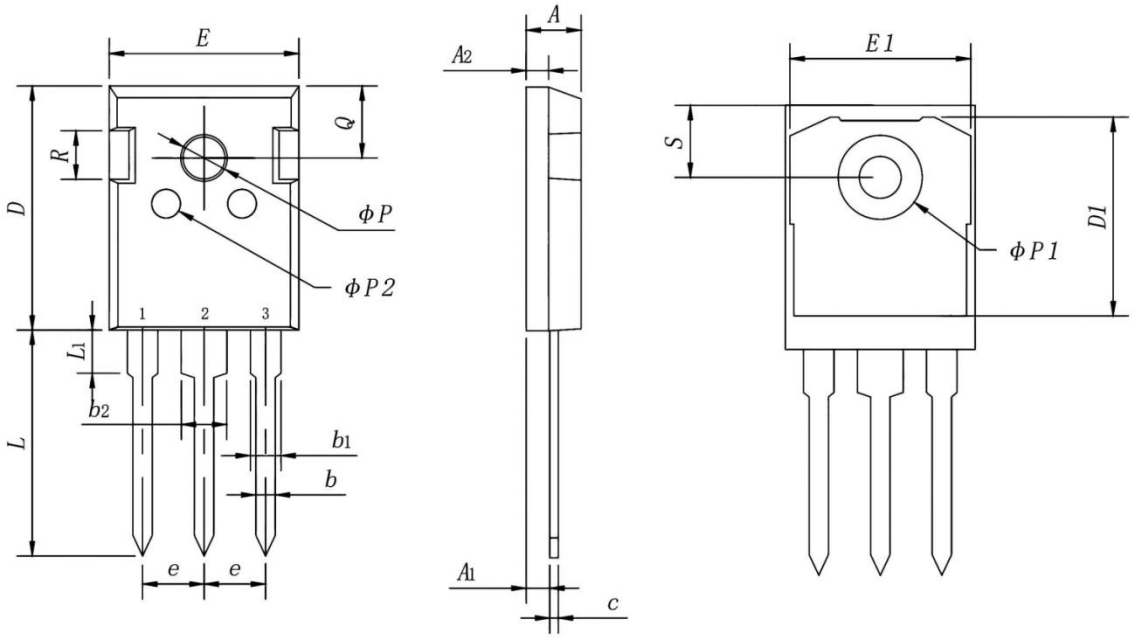


Figure 22. Switching Times vs. $R_{G(ext)}$

TO-247-3L Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.700	5.300	0.185	0.209
A1	2.240	2.580	0.088	0.102
A2	1.800	2.200	0.071	0.087
b	1.000	1.400	0.039	0.055
b1	1.600	2.600	0.063	0.102
b2	2.600	3.600	0.102	0.142
c	0.400	0.800	0.016	0.031
D	20.000	22.000	0.787	0.866
D1	15.240	17.240	0.600	0.679
E	15.500	16.010	0.610	0.630
E1	13.770	14.270	0.542	0.562
e	5.200	5.720	0.205	0.225
L	19.700	20.200	0.776	0.795
L1	3.850	4.450	0.152	0.175
ϕP	3.550	3.650	0.140	0.144
ϕP2	7.140	7.240	0.281	0.285
ϕP3	2.350	2.450	0.093	0.096
Q	5.890	6.400	0.232	0.252
R	4.300	4.900	0.169	0.193
S	6.040	6.300	0.238	0.248